

SOD-123FL Plastic-Encapsulate ESD Protection Diodes

Features

- Low leakage current
- Low clamping voltage
- IEC 61000-4-2 (ESD Air): $\pm 30\text{kV}$
- IEC 61000-4-2 (ESD Contact): $\pm 30\text{kV}$
- IEC 61000-4-5 (Lightning 8/20 μs): 150A

Applications

- I/O Interface.
- AC/DC Power supply
- Notebooks and Handhelds
- Portable Instrumentation, Digital Cameras
- Peripherals, Audio Players, Industrial Equipment

Function Diagram



Reverse Working Voltage
24.0V Max.
High capacitance
300pF(Typ.)

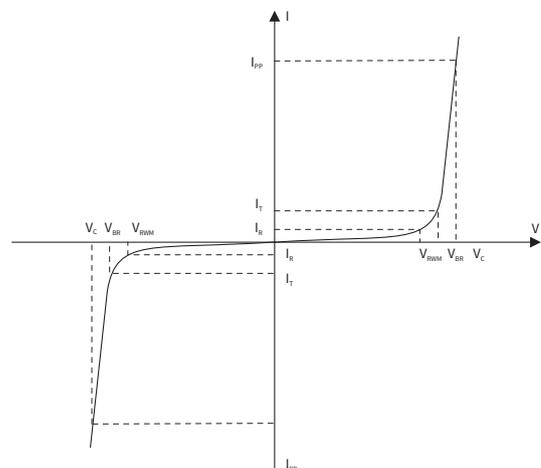


Maximum Ratings (Ta=25°C Unless otherwise specified)

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
V _{ESD}	Electrostatic Discharge Voltage	ESD per IEC 61000-4-2(Air)	± 30	KV
		ESD per IEC 61000-4-2(Contact)	± 30	KV
P _{PP}	Peak Pulse Power	tp = 8/20 μs	6000	W
I _{PP}	Rated Peak Pulse Current	tp = 8/20 μs	150	A
T _J	Operating JunctionTemperature Range	—	-55 to +150	°C
T _{STG}	Operating JunctionTemperature Range	—	-55 to +150	°C

Electrical Parameter

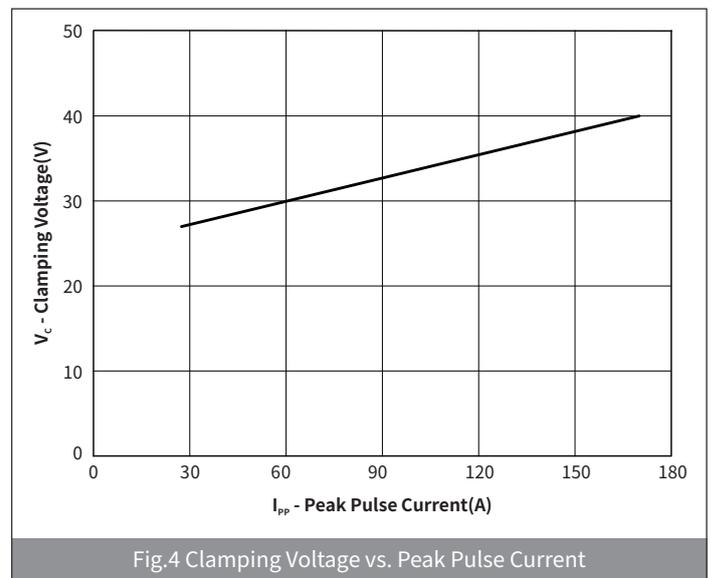
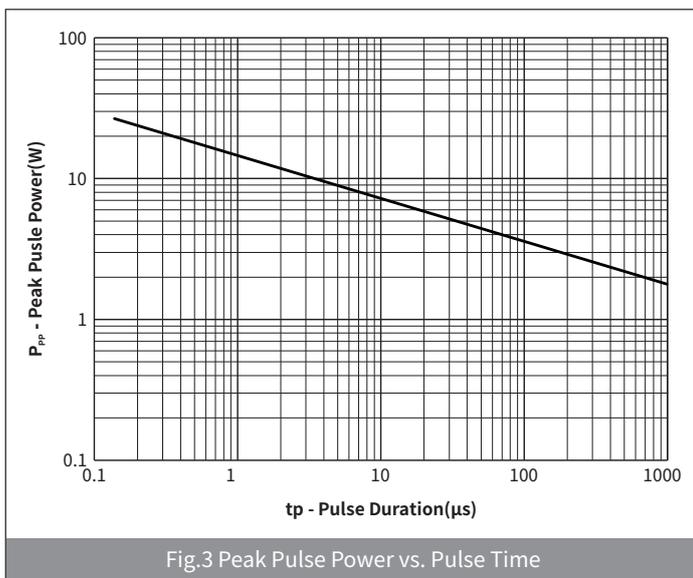
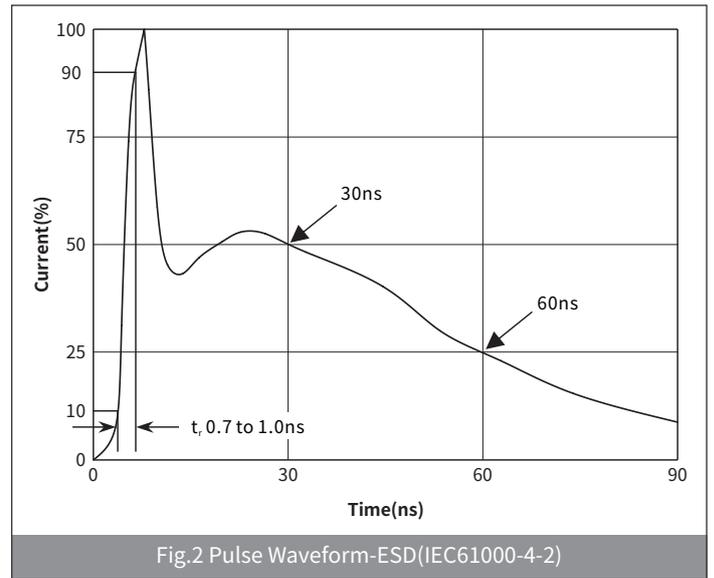
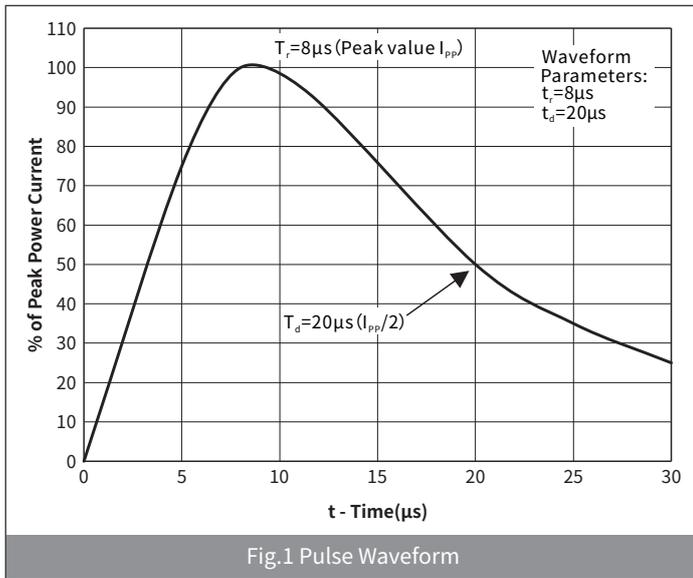
SYMBOL	PARAMETER
V _C	Clamping Voltage @ I _{PP}
V _{BR}	Breakdown Voltage @ I _T
I _{PP}	Peak Pulse Current
I _T	Test Current
I _R	Reverse Leakage Current @ VRWM
V _{RWM}	Peak Reverse Working Voltage
P _{PP}	Peak Pulse Power Dissipation
C _J	Junction Capacitance @ V _R =0V,f=1MHz
I _F	Forward Current
V _F	Forward Voltage @I _F



● **Electrical Characteristics** (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	CONDITION	Min	Typ	Max	UNIT
Peak Reverse Working Voltage	V_{RWM}	$T_a=25^\circ\text{C}$	—	—	24.0	V
Breakdown Voltage	V_{BR}	$I_T=1.0\text{mA}, T_a=25^\circ\text{C}$	26.7	—	29.5	V
Reverse Leakage Current	I_R	$V_{RWM}=24\text{V}, T_a=25^\circ\text{C}$	—	—	1.0	μA
Clamping Voltage	V_C	$I_{PP}=150\text{A}, t_p=8/20\mu\text{s}$	—	—	40.0	V
Junction Capacitance	C_J	$V_{RWM}=0\text{V}, f=1\text{MHz}$	—	300	—	pF

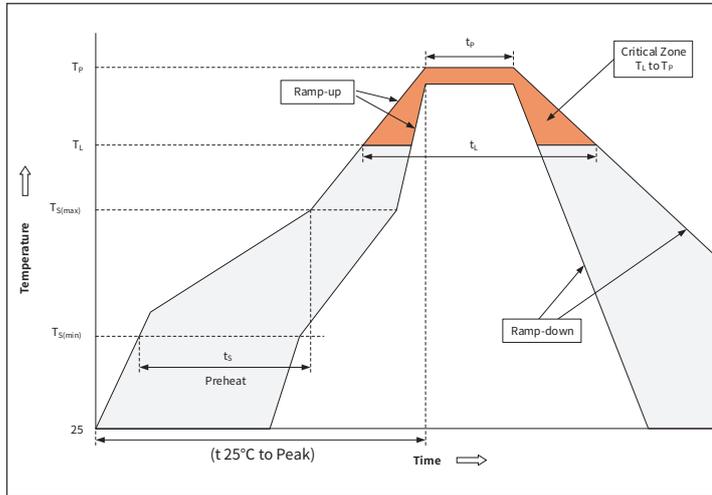
● **Ratings And Characteristics Curves** (Ta=25°C Unless otherwise specified)



Ordering Information

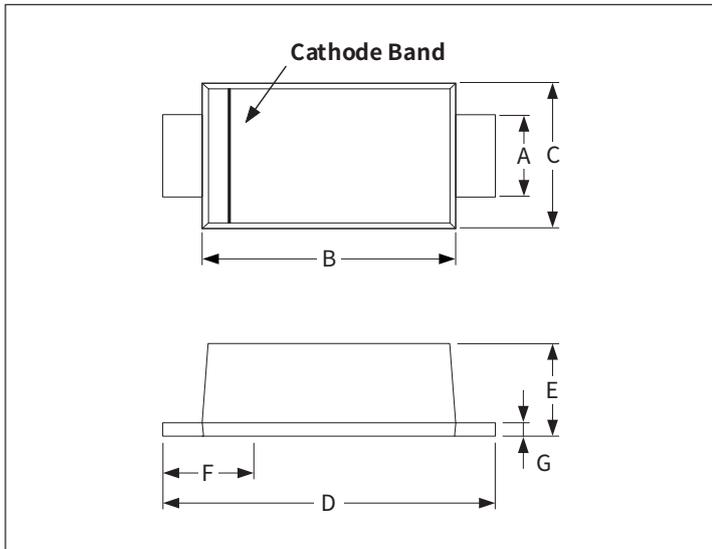
PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOD-123FL	R1	0.0169	3000	45000	180000	7"

Recommended Soldering Conditions



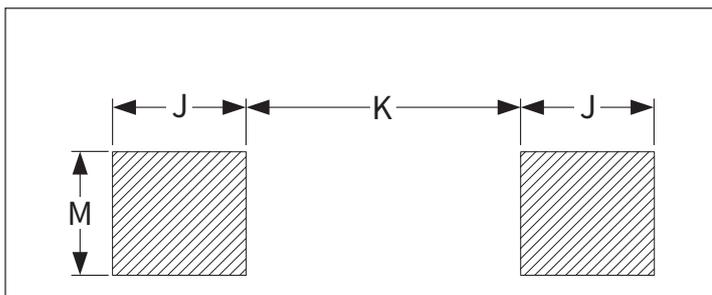
Profile Feature		Pb-Free Assembly
Pre-heat	Temperature Min ($T_{S(min)}$)	+150°C
	Temperature Max ($T_{S(max)}$)	+200°C
	Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{S(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	Temperature (T_L) (Liquid us)	+217°C
	Temperature (t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		20-40secs
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

Package Outline Dimensions (SOD -123FL)



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	0.90	1.10	0.035	0.430
B	2.55	2.85	0.100	0.111
C	1.60	1.90	0.063	0.074
D	3.60	3.90	0.031	0.043
E	1.00	1.20	0.031	0.035
F	0.40	0.90	0.047	0.055
G	0.10	0.25	0.003	0.007

Suggested Pad Layout



Symbol	Dimensions			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
J	1.00	-	0.040	-
K	-	1.90	-	0.074
M	1.50	-	0.059	-